100 V, 2.0 A, Low V_{CE(sat)} PNP Transistor

ON Semiconductor's e²PowerEdge family of low $V_{CE(sat)}$ transistors are miniature surface mount devices featuring ultra low saturation voltage ($V_{CE(sat)}$) and high current gain capability. These are designed for use in low voltage, high speed switching applications where affordable efficient energy control is important.

Typical applications are DC-DC converters and power management in portable and battery powered products such as cellular and cordless phones, PDAs, computers, printers, digital cameras and MP3 players. Other applications are low voltage motor controls in mass storage products such as disc drives and tape drives. In the automotive industry they can be used in air bag deployment and in the instrument cluster. The high current gain allows e²PowerEdge devices to be driven directly from PMU's control outputs, and the Linear Gain (Beta) makes them ideal components in analog amplifiers.

• This is a Pb-Free Device

Rating	Symbol	Мах	Unit
Collector-Emitter Voltage	V _{CEO}	-100	Vdc
Collector-Base Voltage	V _{CB}	-140	Vdc
Emitter-Base Voltage	V_{EB}	-7.0	Vdc
Base Current - Continuous	Ι _Β	1.0	Adc
Collector Current – Continuous – Peak	Ι _C	2.0 3.0	Adc
Total Power Dissipation Total $P_D @ T_A = 25^{\circ}C$ (Note 1) Total $P_D @ T_A = 25^{\circ}C$ (Note 2)	P _D	2.0 0.8	W
Operating and Storage Junction Temperature Range	T _J , T _{stg}	-55 to +150	°C

THERMAL CHARACTERISTICS

Characteristic	Symbol	Мах	Unit
Thermal Resistance, Junction-to-Ambient (Note 1) Junction-to-Ambient (Note 2)	$R_{ extsf{ heta}JA}$	64 155	°C/W
Maximum Lead Temperature for Soldering Purposes, 1/8" from case for 5 seconds	ΤL	260	°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

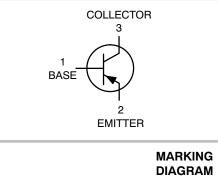
- 1. mounted on 1" sq. (645 sq. mm) Collector pad on FR-4 bd material
- 2. mounted on 0.012" sq. (7.6 sq. mm) Collector pad on FR-4 bd material

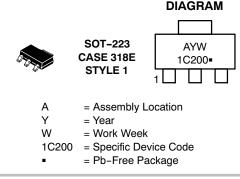


ON Semiconductor®

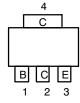
http://onsemi.com

-100 VOLTS, 2.0 AMPS PNP LOW V_{CE(sat)} TRANSISTOR





PIN ASSIGNMENT



Top View Pinout

ORDERING INFORMATION

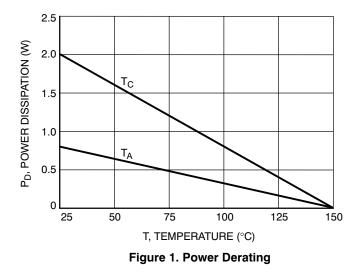
Device	Package	Shipping [†]
NSS1C200T1G	SOT-223 (Pb-Free)	1000/ Tape & Reel
NSS1C200T3G	SOT-223 (Pb-Free)	4000/ Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted)

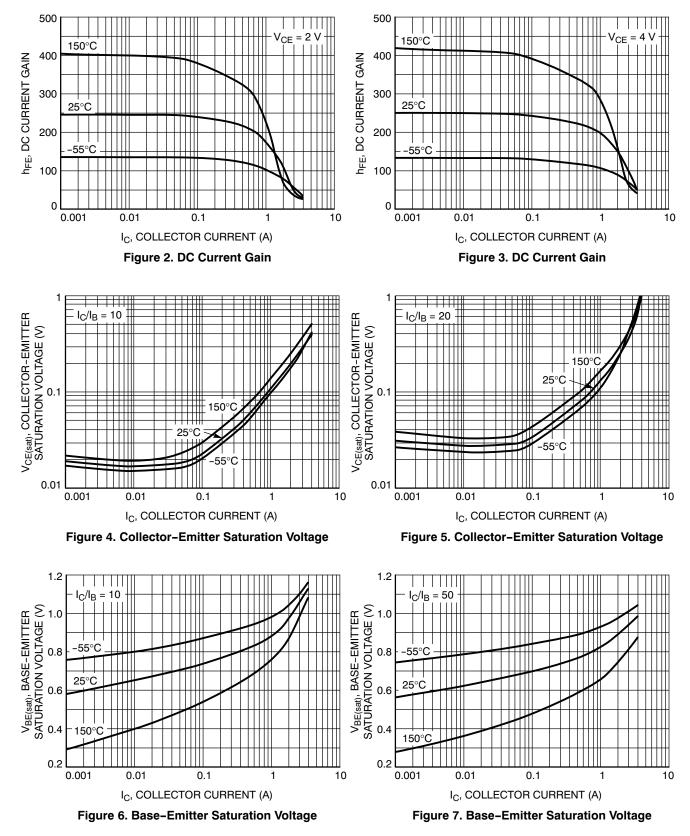
Characteristic	Symbol	Min	Тур	Мах	Unit
OFF CHARACTERISTICS					
Collector – Emitter Breakdown Voltage ($I_C = -10$ mAdc, $I_B = 0$)	V _{(BR)CEO}	-100			Vdc
Collector – Base Breakdown Voltage ($I_C = -0.1 \text{ mAdc}, I_E = 0$)	V _{(BR)CBO}	-140			Vdc
Emitter – Base Breakdown Voltage ($I_E = -0.1 \text{ mAdc}, I_C = 0$)	V _{(BR)EBO}	-7.0			Vdc
Collector Cutoff Current (V _{CB} = -140 Vdc, $I_E = 0$)	I _{CBO}			-100	nAdc
Emitter Cutoff Current (V _{EB} = -6.0 Vdc)	I _{EBO}			-50	nAdc
DN CHARACTERISTICS					
DC Current Gain (Note 3) ($I_C = -10 \text{ mA}, V_{CE} = -2.0 \text{ V}$) ($I_C = -500 \text{ mA}, V_{CE} = -2.0 \text{ V}$) ($I_C = -1.0 \text{ A}, V_{CE} = -2.0 \text{ V}$) ($I_C = -2.0 \text{ A}, V_{CE} = -2.0 \text{ V}$)	hFE	150 120 80 50		360	
Collector - Emitter Saturation Voltage (Note 3) ($I_C = -0.1 \text{ A}, I_B = -0.010 \text{ A}$) ($I_C = -0.5 \text{ A}, I_B = -0.050 \text{ A}$) ($I_C = -1.0 \text{ A}, I_B = -0.100 \text{ A}$) ($I_C = -2.0 \text{ A}, I_B = -0.200 \text{ A}$)	V _{CE(sat)}			-0.040 -0.080 -0.125 -0.220	V
Base – Emitter Saturation Voltage (Note 3) ($I_C = -1.0 \text{ A}, I_B = -0.100 \text{ A}$)	V _{BE(sat)}			-0.950	V
Base – Emitter Turn-on Voltage (Note 3) ($I_C = -1.0 \text{ A}, V_{CE} = -2.0 \text{ V}$)	V _{BE(on)}			-0.850	V
Cutoff Frequency ($I_C = -100 \text{ mA}$, $V_{CE} = -5.0 \text{ V}$, f = 100 MHz)	f _T		120		MHz
Input Capacitance (V _{EB} = 3.0 V, f = 1.0 MHz)	Cibo		200		pF
Output Capacitance (V _{CB} = 10 V, f = 1.0 MHz)	Cobo		22		pF

3. Pulsed Condition: Pulse Width = 300 msec, Duty Cycle \leq 2%.

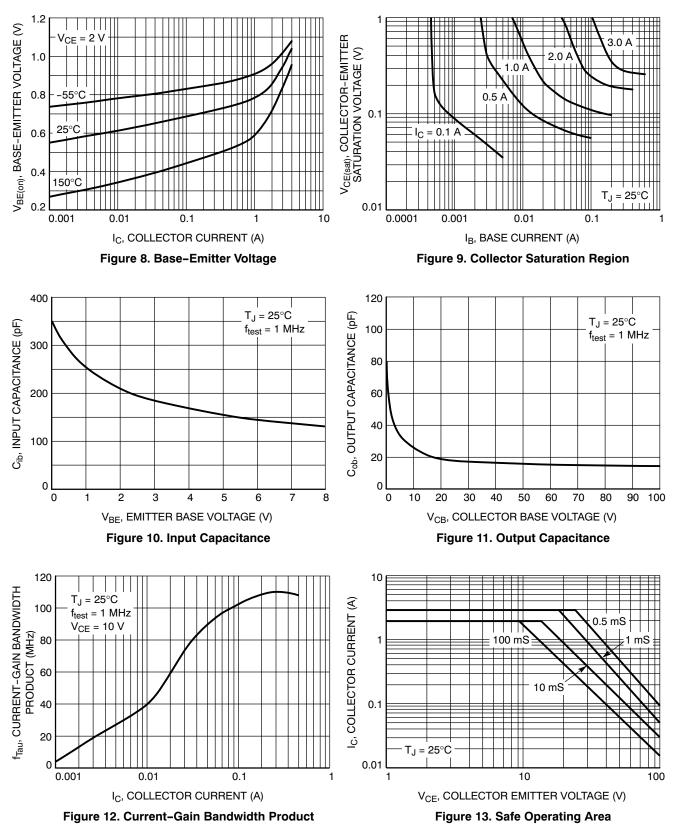


TYPICAL CHARACTERISTICS



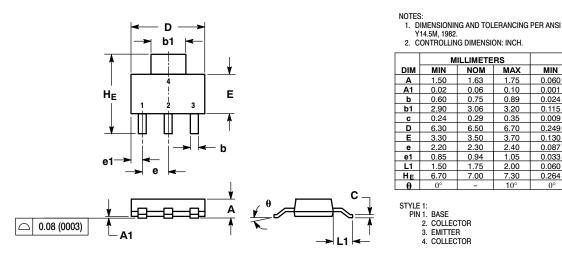


TYPICAL CHARACTERISTICS

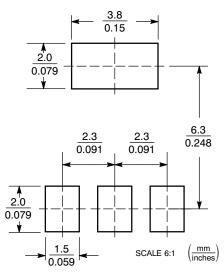


PACKAGE DIMENSIONS

SOT-223 (TO-261) CASE 318E-04 ISSUE L



SOLDERING FOOTPRINT



ON Semiconductor and 💷 are registered trademarks of Semiconductor Components Industries, LLC (SCILLC). SCILLC reserves the right to make changes without further notice to any products herein. SCILLC makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does SCILLC assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. "Typical" parameters which may be provided in SCILLC data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. SCILLC does not convey any license under its patent rights nor the rights of others. SCILLC products are not designed, intended, or authorized for use as components in systems intended for surgical implant into the body, or other applications intended to support or sustain life, or for any other application in which the failure of the SCILLC product could create a situation where personal injury or death may occur. Should Buyer purchase or use SCILLC products for any such unintended or unauthorized application, Buyer shall indemnify and hold SCILLC and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that SCILLC was negligent regarding the design or manufacture of the part. SCILLC is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor P.O. Box 5163, Denver, Colorado 80217 USA Phone: 303-675-2175 or 800-344-3860 Toll Free USA/Canada Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada Email: orderlit@onsemi.com

N. American Technical Support: 800-282-9855 Toll Free USA/Canada Europe, Middle East and Africa Technical Support:

Phone: 421 33 790 2910 Japan Customer Focus Center Phone: 81-3-5773-3850

ON Semiconductor Website: www.onsemi.com

INCHES

NOM

0.064

0.002

0.030

0.121

0.012

0.256

0.138

0.091

0.037

0.069

0.276

MAX

0.068

0.004

0.035

0.126

0.014

0.263

0.145

0.094

0.041

0.078

0.287 10

MIN

0.060

0.001

0.024

0.115

0.009

0.249

0.130

0.087

0.033

0.060

0.264

Order Literature: http://www.onsemi.com/orderlit

For additional information, please contact your local Sales Representative